

250V 0.4A Fast Switching Diode - BAS21

Small-Signal high voltage switching diode in bare die form

Rev 1.0 27/9/20

Features:

- Fast Switching Speed
- High conductance
- High minimum breakdown voltage 275V
- General purpose switching applications
- High reliability tested grades.

Ordering Information

The following part suffixes apply:

- No suffix MIL-STD-750 /2073 Visual Inspection
- "H" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class H LAT
- "K" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

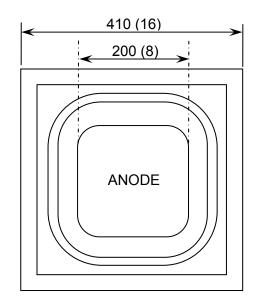
For further information on LAT process flows see below.

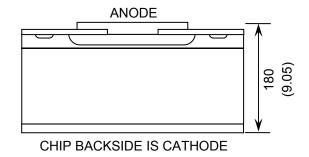
www.siliconsupplies.com\quality\bare-die-lot-qualification

Supply Formats:

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- Die Thickness <> 180µm(7 Mils) On request
- With additional electrical selection On request

Die Dimensions in µm (mils)





Mechanical Specification

Die Size (Unsawn)	410 x 410 16.14 x 16.14	µm mils	
Anode Pad Size	200 X 200 7.87 X 7.87	μm mils	
Die Thickness	180 (±15) 7.09 (±0.59)	µm mils	
Top Metal Composition	Al		
Back Metal Composition	AuAs		





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Absolute Maximum Ratings¹ T_J = 25°C unless otherwise stated

PARAMETER	SYMBOL VALUE		UNIT
Non-repetitive Peak Reverse Voltage	V_{RSM}	300	V
Repetitive Peak Reverse Voltage	V_{RRM}	275	V
Working Peak Reverse Voltage	V_{RWM}	250	V
Average Rectified Output Current	Io	200	mA
DC Forward Current	l _F	400	mA
Recurrent Peak Forward Current	l _f	625	mA
Non-repetitive	ve I	Pulse width 1s 1	A
Peak forward surge current	I _{FSM}	Pulse width 1µs 4	^
Power Dissipation	P_D	250	mW
Operating Junction temperature	TJ	-55 to 175	°C
Storage Temperature Range	T _{STG}	-65 to 200	°C

^{1.} Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

Electrical Characteristics T_J = 25°C unless otherwise stated

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Breakdown Voltage	V _R	I _R = 100μA	275	-	-	V
Forward Voltage ²	V _F	I _F = 100mA	-	-	1.00	V
	V F	I _F = 200mA	-	-	1.25	
Reverse Leakage I _R	l _D	V _R = 200V	-	-	0.10	μА
	ir.	V _R = 200V, T _J = 150°C	-	-	100	
Total Capacitance	Ст	V _R = 0V, f = 1MHz	-	-	5	pF
Reverse Recovery Time	t _{rr}	$I_F = I_R = 30\text{mA},$ $I_m = 3\text{mA}, R_L = 100\Omega$	-	-	50	ns

2. Pulse Width = 8.3ms, Non-recurrent square wave





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Typical Characteristics T_J = 25°C unless otherwise stated

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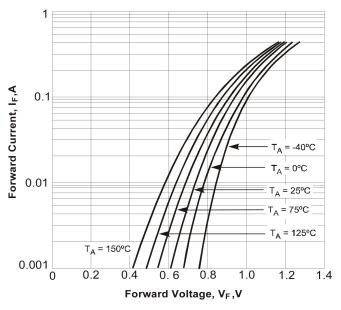


FIGURE 1. Forward Voltage Characteristics

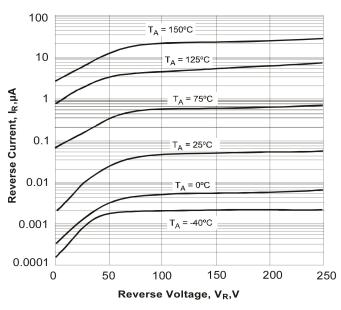


FIGURE 2. Reverse Current Characteristics

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